IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants: B. Kim et al. Attorney Docket No.: SEMT119849

Application No.: 10/700,782 Art Unit: 1795 / Confirmation No: 5493

Filed: November 3, 2003 Examiner: E. Wong

Title: BATH AND METHOD FOR HIGH RATE COPPER DEPOSITION

AMENDMENT AFTER NON-FINAL REJECTION

Seattle, Washington 98101

April 21, 2008

TO THE COMMISSIONER FOR PATENTS:

INTRODUCTORY COMMENTS

Please amend the above-identified application as follows:

Amendments to the Claims are reflected in the listing of the claims, which begins on page 2 of this paper.

Remarks/Arguments begin on page 7 of this paper.